# 2SD2453

# Silicon NPN triple diffusion planar type

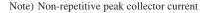
For high current transfer ratio and power amplification

### ■ Features

- High forward current transfer ratio h<sub>FE</sub>
- Low collector-emitter saturation voltage V<sub>CE(sat)</sub>

# ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (En	V <sub>CBO</sub>	80	V	
Collector-emitter voltage	V <sub>CEO</sub>	60	V	
Emitter-base voltage (Collector open)		$V_{EBO}$	6	V
Collector current	$I_C$	2	A	
Peak collector current *		$I_{CP}$	4	A
Base current		$I_{B}$	1	A
Collector power	$T_C = 25^{\circ}C$	P <sub>C</sub>	10	W
dissipation			1	
Junction temperature		$T_j$	150	°C
Storage temperature		$T_{stg}$	-55 to +150	°C



# Unit: mm 6.5±0.1 5.3±0.1 4.35±0.1 0.5±0.1 0.5±0.1 0.5±0.1 0.5±0.1 0.5±0.1 1.0±0.1 0.75±0.1 (4.35) (3.0) 1: Base 2: Collector 3: Emitter EIAJ: SC-63 U-G2 Package

Note) Self-supported type package is also prepared.

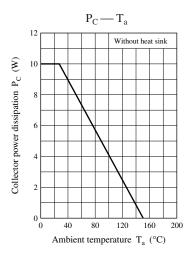
## ■ Electrical Characteristics $T_a = 25$ °C

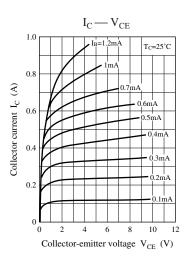
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 25 \text{ mA}, I_B = 0$	60			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 80 \text{ V}, I_{E} = 0$			100	μΑ
Collector-emitter cutoff current (Base open)	$I_{CEO}$	$V_{CE} = 40 \text{ V}, I_{B} = 0$			100	μΑ
Emiter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 6 \text{ V}, I_C = 0$			100	μΑ
Forward current transfer ratio *	h <sub>FE</sub>	$V_{CE} = 4 \text{ V}, I_{C} = 0.5 \text{ A}$	500		2500	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 2 \text{ A}, I_B = 0.05 \text{ A}$			1	V
Transition frequency	$f_T$	$V_{CE} = 12 \text{ V}, I_{C} = 0.2 \text{ A}, f = 10 \text{ MHz}$		50		MHz

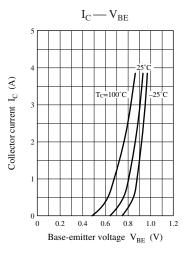
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

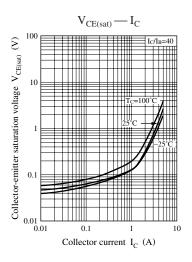
## 2. \*: Rank classification

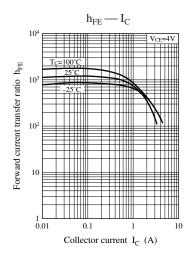
Rank	Q	R	S
$h_{FE}$	500 to 1 000	800 to 1500	1 200 to 2 500

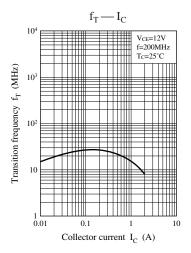


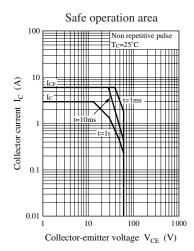












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